TSSP77P38



Vishay Semiconductors

IR Detector for Mid Range Proximity Sensor





LINKS TO ADDITIONAL RESOURCES



DESCRIPTION

The TSSP77P38 is a compact infrared detector module for proximity sensing application. It receives 38 kHz modulated signals and has a peak sensitivity of 940 nm.

The length of the detector's output pulse varies in proportion to the amount of light reflected from the object being detected.

FEATURES

- Up to 2 m for proximity sensing
- Very low supply current
- Photo detector and preamplifier in one package
- Shielding against EMI
- Supply voltage: 2.0 V to 5.5 V
- Visible light is suppressed by IR filter
- Capable of side or top view
- Insensitive to supply voltage ripple and noise
- Two lenses for high sensitivity and wide receiving angle
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

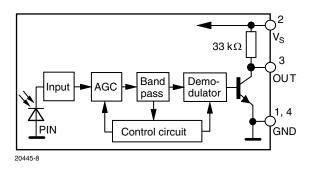
APPLICATIONS

- Object approach detection for activation of displays and user consoles, signaling of alarms, etc.
- Simple gesture controls
- Differentiation of car arrival, static, car departure in parking lots
- · Reflective sensors for toilet flush
- Navigational sensor for robotics

DESIGN SUPPORT TOOLS

- <u>3D models</u>
- <u>Window size calculator</u>

BLOCK DIAGRAM



Rev. 2.7, 27-May-2025

1

Document Number: 82481

s of compliance

RoHS

FREE

<u>GREEN</u>

(5-2008)

TSSP77P38

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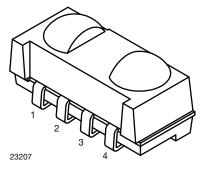
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MECHANICAL DATA

Pinning:

ISHA

1, 4 = GND, 2 = V_S , 3 = OUT

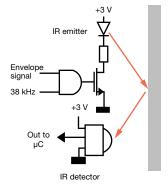


ORDERING CODE

Taping:

TSSP77P38TT - top view taped, 2200 pcs/reel TSSP77P38TR - side view taped, 2300 pcs/reel

PROXIMITY SENSING



PARTS TABLE			
Carrier frequency	38 kHz	TSSP77P38	
Package		Heimdall	
Pinning		1, 4 = GND, 2 = V _S , 3 = OUT	
Dimensions (mm)		6.8 W x 3.0 H x 3.2 D	
Mounting		SMD	
Application		Proximity sensors	
Special options		 Extended temperature range: <u>www.vishay.com/doc?82738</u> Narrow optical filter: <u>www.vishay.com/doc?81590</u> Wide optical filter: <u>www.vishay.com/doc?82726</u> 	

ABSOLUTE MAXIMUM RA	JTE MAXIMUM RATINGS			
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		V _S	-0.3 to +6	V
Supply current		IS	5	mA
Output voltage		Vo	-0.3 to (V _S + 0.3)	V
Output current		Ι _Ο	5	mA
Junction temperature		Tj	100	°C
Storage temperature range		T _{stg}	-25 to +85	°C
Operating temperature range		T _{amb}	-25 to +85	°C
Power consumption	T _{amb} ≤ 85 °C	P _{tot}	10	mW

Note

• Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability

TSSP77P38



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ELECTRICAL AND OPTI	CAL CHARACTERISTICS (T	amb = 25 °C	C, unless o	therwise sp	pecified)	
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		Vs	2.0	-	5.5	V
Supply current	$V_{\rm S} = 3.3 \text{ V}, \text{ E}_{\rm e} = 0$	I _{SD}	0.25	0.35	0.45	mA
Supply current	$E_v = 40$ klx, sunlight	I _{SH}	-	0.45	-	mA
Receiving distance	Direct line of sight, IR diode TSAL6200, I _F = 50 mA, test signal see Fig. 1	d	-	21	-	m
Output voltage low	$I_{OSL} = 0.5 \text{ mA}, E_e = 0.7 \text{ mW/m}^2,$ test signal see Fig. 1	V _{OSL}	-	-	100	mV
Minimum irradiance	Pulse width tolerance: $ t_{pi} - 5/f_o < t_{po} < t_{pi} + 5/f_{o,} \\ test signal see Fig. 1 $	E _{e min.}	-	0.15	0.3	mW/m ²
Maximum irradiance	$\begin{array}{c} \mbox{Pulse width tolerance:} \\ t_{pi} - 5/f_o < t_{po} < t_{pi} + 5/f_o, \\ \mbox{test signal see Fig. 1} \end{array}$	E _{e max} .	30	-	-	W/m ²
Directivity	Angle of half receiving distance	φ1/2	-	± 50	-	0

TYPICAL CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)

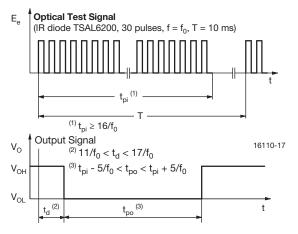


Fig. 1 - Output Active Low

Rev. 2.7, 27-May-2025

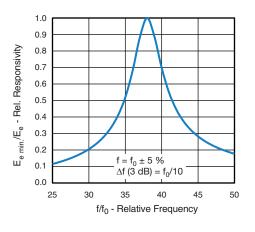
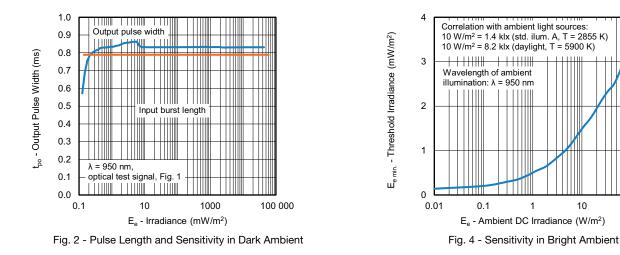


Fig. 3 - Frequency Dependence of Responsivity



Document Number: 82481

100

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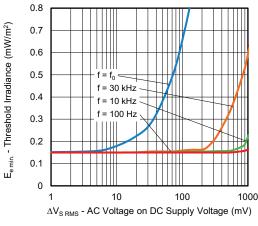


Fig. 5 - Sensitivity vs. Supply Voltage Disturbances

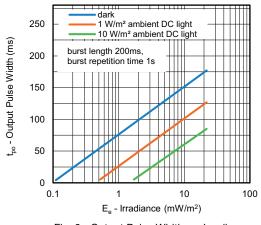


Fig. 6 - Output Pulse Width vs. Irradiance

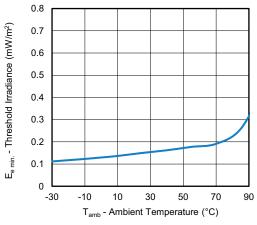


Fig. 7 - Sensitivity vs. Ambient Temperature

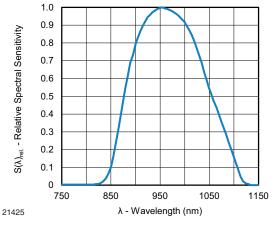


Fig. 8 - Relative Spectral Sensitivity vs. Wavelength

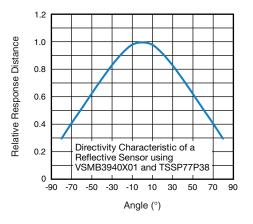


Fig. 9 - Angle Characteristic

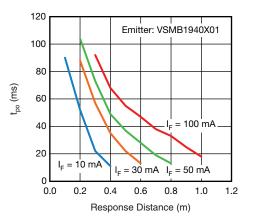
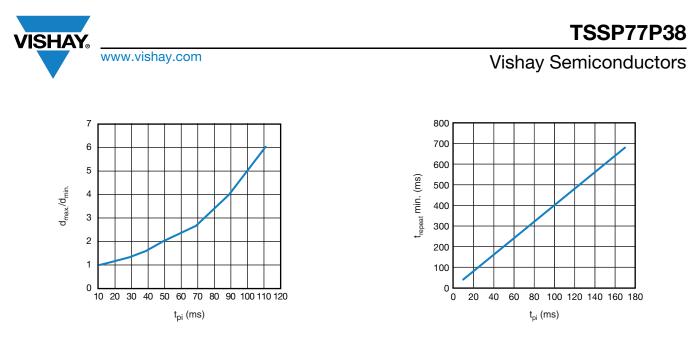


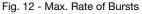
Fig. 10 - t_{po} vs. Distance Kodak Gray Card Plus 15 %

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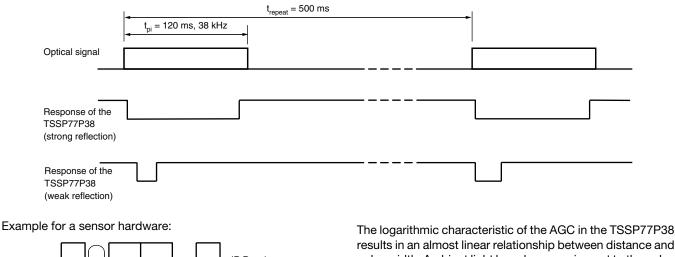


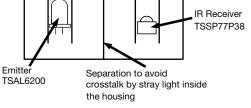




The typical application of the TSSP77P38 is a reflective sensor with analog information contained in its output. Such a sensor is evaluating the time required by the AGC to suppress a quasi continuous signal. The time required to suppress such a signal is longer when the signal is strong than when the signal is weak, resulting in a pulse length corresponding to the distance of an object from the sensor. This kind of analog information can be evaluated by a microcontroller. The absolute amount of reflected light depends much on the environment and is not evaluated. Only sudden changes of the amount of reflected light, and therefore changes in the pulse width, are evaluated using this application.

Example of a signal pattern:





There should be no common window in front of the emitter and receiver in order to avoid crosstalk by guided light through the window.

results in an almost linear relationship between distance and pulse width. Ambient light has also some impact to the pulse width of this kind of sensor, making the pulse shorter.

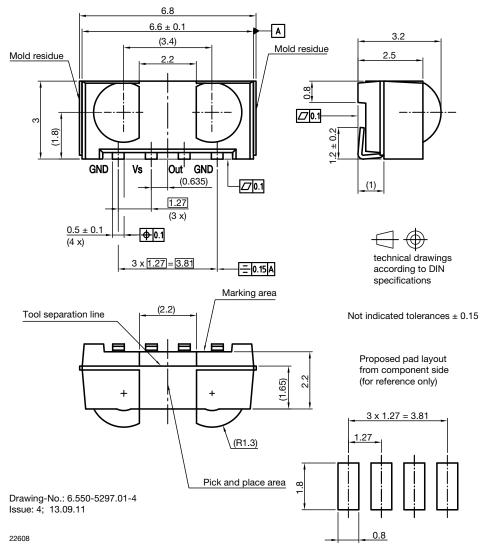
Rev. 2.7, 27-May-2025

5





PACKAGE DIMENSIONS in millimeters





• Use a soldering iron of 25 W or less. Adjust the

· Handle products only after the temperature has cooled off

temperature of the soldering iron below 300 °C



ASSEMBLY INSTRUCTIONS

Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

300 max. 260 °C 255 °C 250 245 °C 240 °C 217 °C Temperature (°C) 200 max. 20 s 150 max. 120 s max. 100 s 100 Max. ramp down 6 °C/s Max. ramp up 3 °C/s 50 Max. 2 cycles allowed 0 0 50 100 150 200 250 300 Time (s) 19800

Manual Soldering

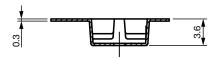
Finish soldering within 3 s

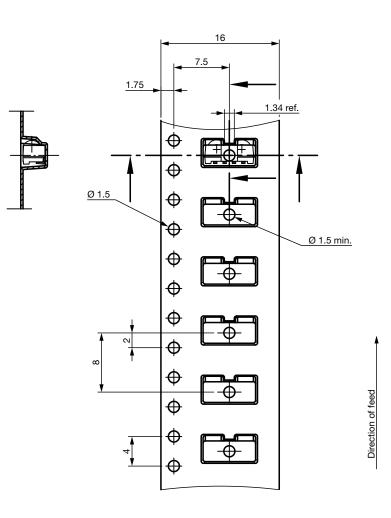
VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE

Rev. 2.7, 27-May-2025



TAPING VERSION TSSP77P38TR DIMENSIONS in millimeters





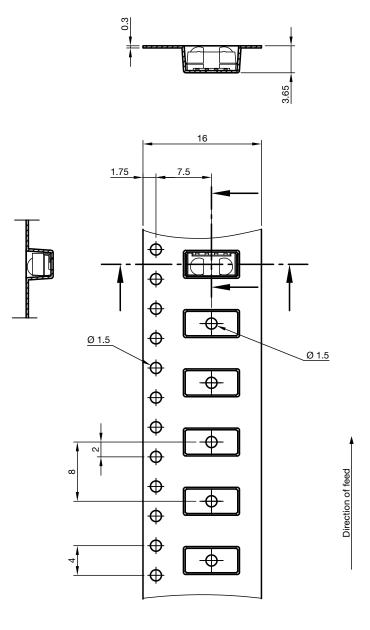


technical drawings according to DIN specifications

Drawing-No.: 9.700-5337.01-4 Issue: 2; 06.10.15



TAPING VERSION TSSP77P38TT DIMENSIONS in millimeters





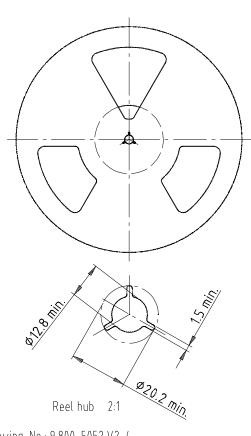
technical drawings according to DIN specifications

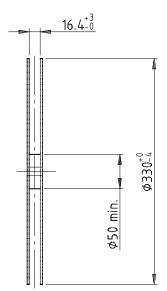
Drawing-No.: 9.700-5338.01-4 Issue: 4; 12.06.13





REEL DIMENSIONS in millimeters





Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

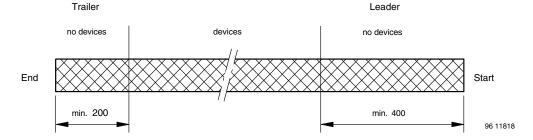
Tape width 16



technical drawings according to DIN specifications



LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 ± 10 mm/min. 165° to 180° peel angle

Rev. 2.7, 27-May-2025

10



OUTER PACKAGING

The sealed reel is packed into a pizza box.

CARTON BOX DIMENSIONS in mi	llimeters		
	hickness Width	Length	
	THICKNESS	WIDTH	LENGTH
Pizza box (SMD and heimdall) (taping in reels)	50	340	340

LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxx+	Company logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	Ν	8
Plant-code	Ν	2
Sequence-number	Х	3
Quantity	Ν	8
Total length	-	21
SHORT BAR CODE BOTTOM	ТҮРЕ	LENGTH
Selection-code	Х	3
Data-code	Ν	3
Batch-number	X	10
Filter	-	1
Total length	_	17

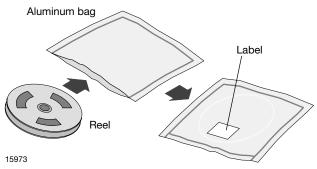
Rev. 2.7, 27-May-2025

Document Number: 82481



DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity \leq 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 $^\circ\text{C}$ + 5 $^\circ\text{C}$ and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC[®] standard J-STD-020 level 4 label is included on all dry bags.

Vishay Semiconductors



EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS (example)

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



22178

Rev. 2.7, 27-May-2025



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1